



Product Change Notification

113737 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia/PRC Pacific Contact: apagccb@intel.com

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Product Change Notification

Change Notification #: 113737 - 00

Change Title: Intel® 8 Series Chipsets
PCN 113737-00, Transport Media,
Alternate source for Carrier tape and
Cover tape

Date of Publication: April 14, 2015

Key Characteristics of the Change:

Transport Media

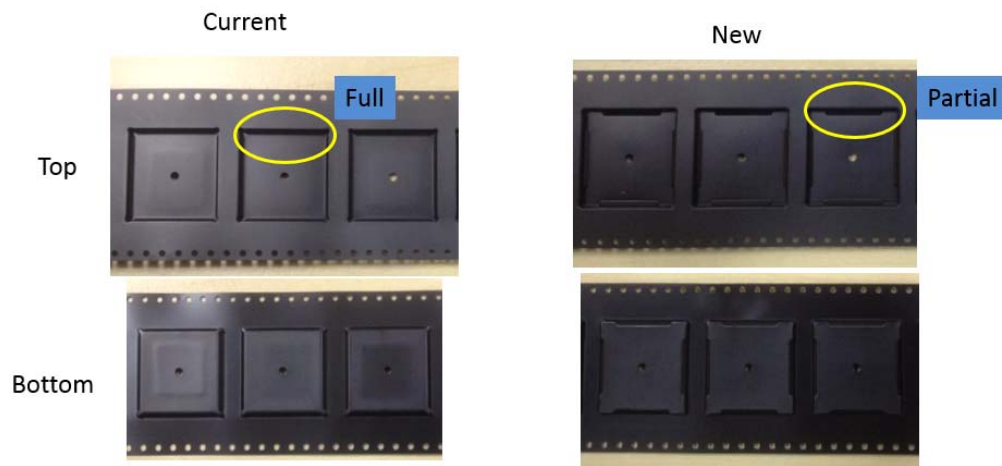
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 18, 2015
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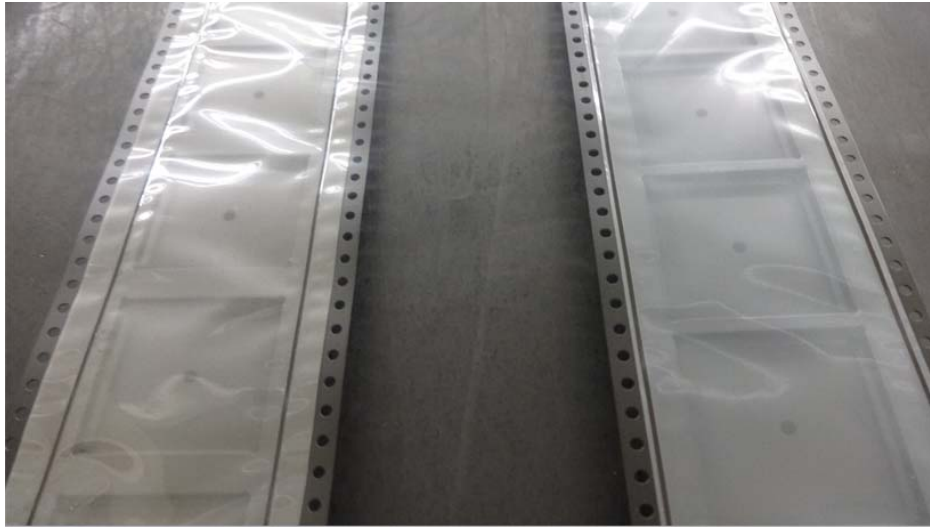
Description of Change to the Customer:

To ensure the supply of the Intel® 8 Series Chipset products in tape and reel, Intel is adding an alternate source for both carrier tape and cover tape.

Carrier tape changes: there has been no change in form fit, function or quality of the carrier tape, only the slight change in appearance as indicated below. The ledge on the current pocket provides full contact with the units. The ledge on the new carrier tape pocket provides partial contact with the units, but does not impact loading or removing the units. See carrier tape images below:



Cover tape changes: the cover tape transparency may appear slightly different to customers as indicated in the picture below. No changes to the composition or the dimensions of the cover tape have been made.



Customer Impact of Change and Recommended Action:

Customers may receive a mixture of carrier tape and cover tape materials as Intel strives to ensure an uninterrupted supply for our customers.

Products Affected / Intel Ordering Codes:

Marketing Name	Stepping	Platform	Product Code	S-Spec	MM#
Intel® DH82Q87 Platform Controller Hub	C2	DESKTOP	DH82Q87	S R173	929132
Intel® DH82Q85 Platform Controller Hub	C2	DESKTOP	DH82Q85	S R174	929133
Intel® DH82H87 Platform Controller Hub	C2	DESKTOP	DH82H87	S R175	929134
Intel® DH82Z87 Platform Controller Hub	C2	DESKTOP	DH82Z87	S R176	929136
Intel® DH82H81 Platform Controller Hub	C2	DESKTOP	DH82H81	S R177	929137
Intel® DH82B85 Platform Controller Hub	C2	DESKTOP	DH82B85	S R178	929138
Intel® DH82Q87 Platform Controller Hub	C2	DESKTOP	DH82Q87	S R19E	929899
Intel® DH82Z97 Platform Controller Hub	A0	DESKTOP	DH82Z97	S R1JJ	930963
Intel® DH82H97 Platform Controller Hub	A0	DESKTOP	DH82H97	S R1JK	930964

PCN Revision History:

Date of Revision:
April 14, 2015

Revision Number:
00

Reason:
Originally Published PCN